

N-channel 80 V 17 mΩ standard level MOSFET in TO220Rev. 3 — 27 September 2011Product data

Product data sheet

Product profile 1.

1.1 General description

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- **1.3 Applications**
 - DC-to-DC converters
 - Load switching

- Suitable for standard level gate drive sources
- Motor control
- Server power supplies

1.4 Quick reference data

Table 1. **Quick reference data**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	-	80	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>	-	-	50	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see Figure 2	-	-	103	W
Tj	junction temperature		-55	-	175	°C
Static cha	aracteristics					
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 10 \text{ A};$ $T_j = 100 \text{ °C}; \text{ see } \frac{\text{Figure } 12}{100 \text{ C}}$	-	15.2	29	mΩ
		V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C; see <u>Figure 13</u>	-	13.7	17	mΩ
Dynamic	characteristics					
Q_{GD}	gate-drain charge	V_{GS} = 10 V; I_{D} = 25 A;	-	6	-	nC
Q _{G(tot)}	total gate charge	V _{DS} = 40 V; see <u>Figure 14;</u> see <u>Figure 15</u>	-	26	-	nC
Avalanche ruggedness						
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ \begin{array}{l} V_{GS} = 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \\ I_{D} = 50 \; A; \; V_{sup} \leq 80 \; V; \\ R_{GS} = 50 \; \Omega; \; unclamped \end{array} $	-	-	55	mJ



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2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		-
2	D	drain	mb	
3	S	source		
mb	D	mounting base; connected to drain		mbb076 S

SOT78 (TO-220AB)

3. Ordering information

Table 3.Ordering information

Type number	Package		
	Name	Description	Version
PSMN017-80PS	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

4. Limiting values

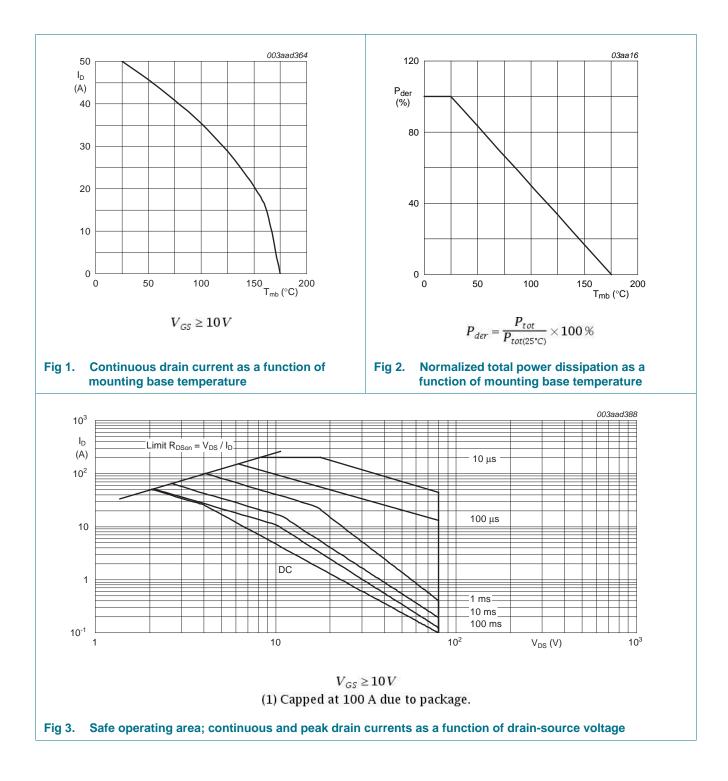
Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	80	V
V _{DGR}	drain-gate voltage	T _j ≥ 25 °C; T _j ≤ 175 °C; R _{GS} = 20 kΩ	-	80	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V_{GS} = 10 V; T_{mb} = 100 °C; see <u>Figure 1</u>	-	35	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	-	50	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3	-	200	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	103	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-drai	in diode				
I _S	source current	T _{mb} = 25 °C	-	50	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$	-	200	А
Avalanche I	ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 50 A; V_{sup} ≤ 80 V; R_{GS} = 50 Ω; unclamped	-	55	mJ

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5. Thermal characteristics

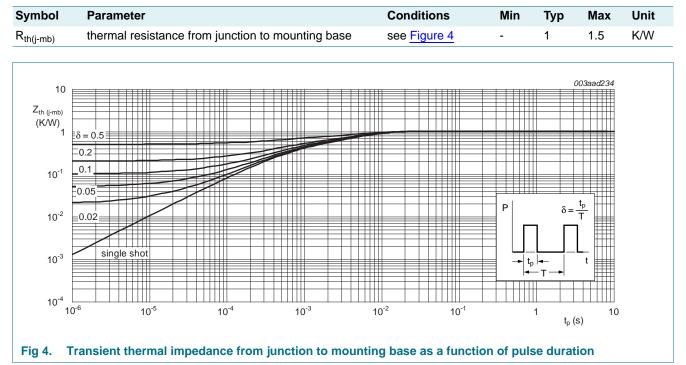


Table 5. Thermal characteristics

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6. Characteristics

Table 6. Characteristics

Tested to JEDEC standards where applicable.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V _{(BR)DSS}	drain-source breakdown	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ C$	73	-	-	V
	voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$	80	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 11</u>	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see Figure 10; see Figure 11	-	-	4.8	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 10; see Figure 11	2	3	4	V
I _{DSS}	drain leakage current	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.3	2	μΑ
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$	-	-	50	μA
I _{GSS}	gate leakage current	V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	10	100	nA
		V_{GS} = 20 V; V_{DS} = 0 V; T_j = 25 °C	-	10	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 10 A; T _j = 175 °C; see <u>Figure 12</u>	-	32.64	40.8	mΩ
		V_{GS} = 10 V; I _D = 10 A; T _j = 100 °C; see <u>Figure 12</u>	-	15.2	29	mΩ
		V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C; see <u>Figure 13</u>	-	13.7	17	mΩ
R _G	internal gate resistance (AC)	f = 1 MHz	-	1	-	Ω
Dynamic ch	aracteristics					
Q _{G(tot)}	total gate charge	$I_D = 0 \text{ A}; \text{ V}_{DS} = 0 \text{ V}; \text{ V}_{GS} = 10 \text{ V}$	-	22	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V}; \text{see}$ Figure 14; see Figure 15	-	26	-	nC
Q _{GS}	gate-source charge		-	7.7	-	nC
Q _{GS(th)}	pre-threshold gate-source charge		-	4.6	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge		-	3	-	nC
Q _{GD}	gate-drain charge		-	6	-	nC
V _{GS(pl)}	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; \text{ see } \frac{\text{Figure } 15}{15}$	-	4.7	-	V
C _{iss}	input capacitance	V _{DS} = 40 V; V _{GS} = 0 V; f = 1 MHz;	-	1573	-	pF
C _{oss}	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{100}$	-	154	-	pF
C _{rss}	reverse transfer capacitance		-	88	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 40 \text{ V}; \text{ R}_{L} = 1.6 \Omega; V_{GS} = 10 \text{ V}; \label{eq:VDS}$	-	14	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \ \Omega$	-	12	-	ns
t _{d(off)}	turn-off delay time		-	27	-	ns
t _f	fall time		-	8	-	ns

Symbol

V_{SD}

Source-drain diode

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Typ

0.79

Max

1.2

Unit

V

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Min

see Figure 17 $I_{S} = 40 \text{ A}; \text{ d}I_{S}/\text{d}t = 100 \text{ A}/\mu\text{s}; \\ V_{GS} = 0 \text{ V}; \text{ V}_{DS} = 40 \text{ V}$ reverse recovery time 41 t_{rr} -ns recovered charge nC Qr 55 --003aad458 003aad460 60 50 I_D I_D 8 (A) (A) 10 6.5 50 40 20 16 , 5.5 40 30 5 30 20 20 T_j = 175 °C $V_{GS}(V) = 4.5$ 10 10 T:= 25 °C 0 0 0 0.5 1 1.5 2 0 2 6 4 V_{DS} (V) V_{GS} (V) $T_{i} = 25 \,^{\circ}C; t_{p} = 300 \,\mu s$ $V_{DS} = 15V$ Output characteristics: drain current as a Transfer characteristics: drain current as a Fig 5. Fig 6. function of drain-source voltage; typical values function of gate-source voltage; typical values 003aad464 003aad465 2500 70 g_{fs} C_{iss} С (S) (pF) 60 2000 50 C_{rss} 40 1500 30 20 1000 10 0 500 I_D (A) 50 V_{GS} (V) ¹² 3 6 10 20 30 0 9 0 40 $V_{DS} = 0V; f = 1MHz$ $T_j = 25 \,^{\circ}C; V_{DS} = 15V$ Fig 8. Fig 7. Input and reverse transfer capacitances as a Forward transconductance as a function of function of gate-source voltage; typical values drain current; typical values

Conditions

I_S = 10 A; V_{GS} = 0 V; T_i = 25 °C;

Table 6. Characteristics ...continued

Parameter

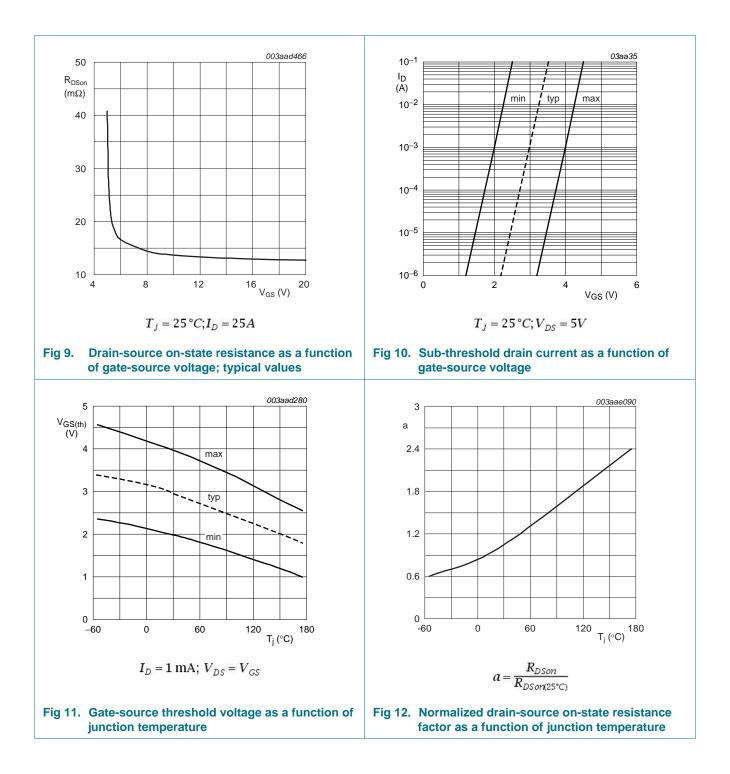
Tested to JEDEC standards where applicable.

source-drain voltage

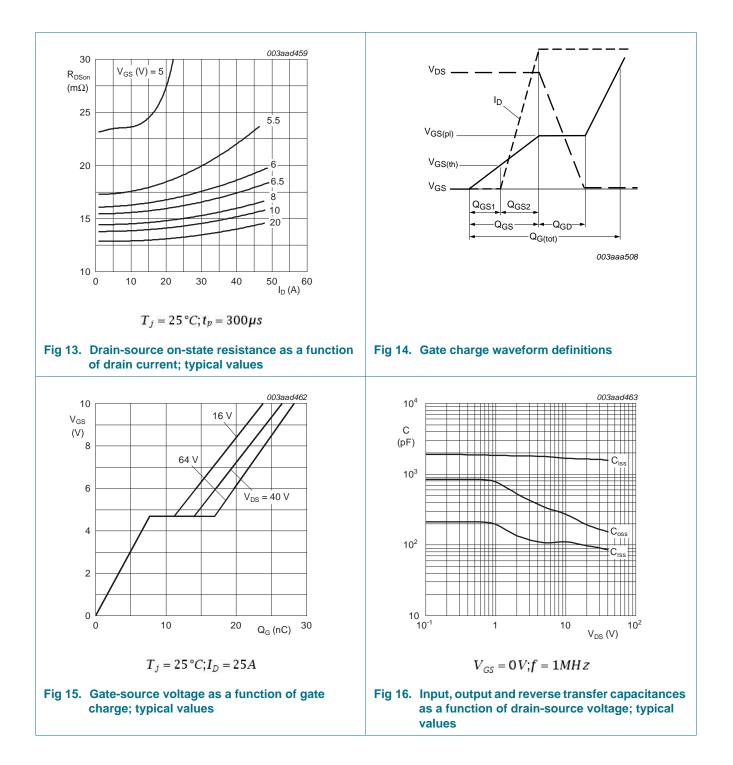
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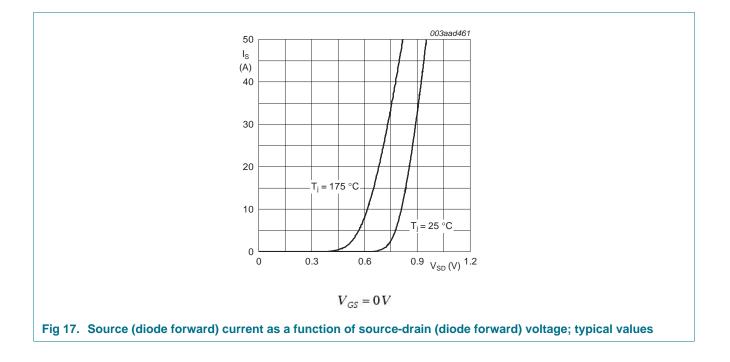
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Package outline 7.

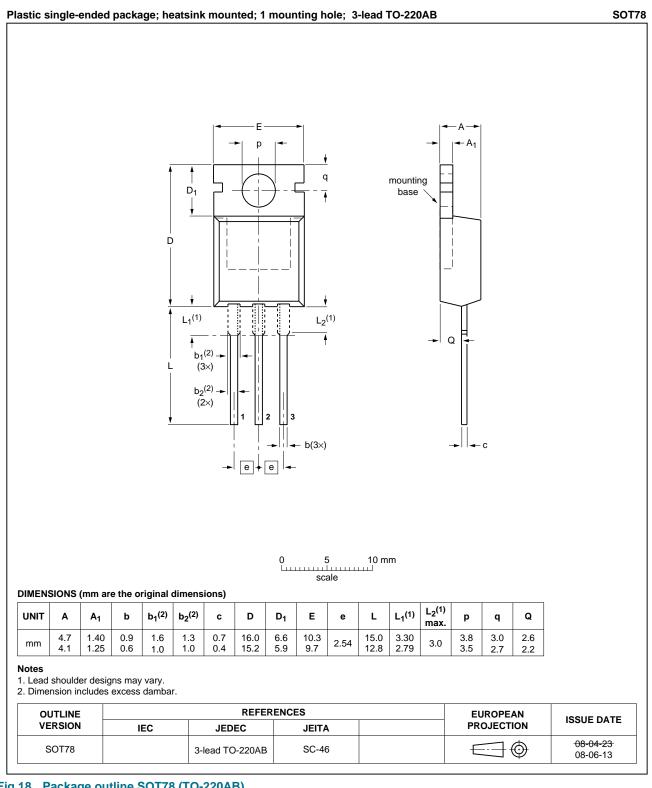


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN017-80PS v.3	20110927	Product data sheet	-	PSMN017-80PS v.2
Modifications:	 Various changes 	s to content.		
PSMN017-80PS v.2	20101101	Product data sheet	-	PSMN017-80PS v.1

9. Legal information

9.1 Data sheet status

Document status [1] [2]	Product status 3	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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